

HSF

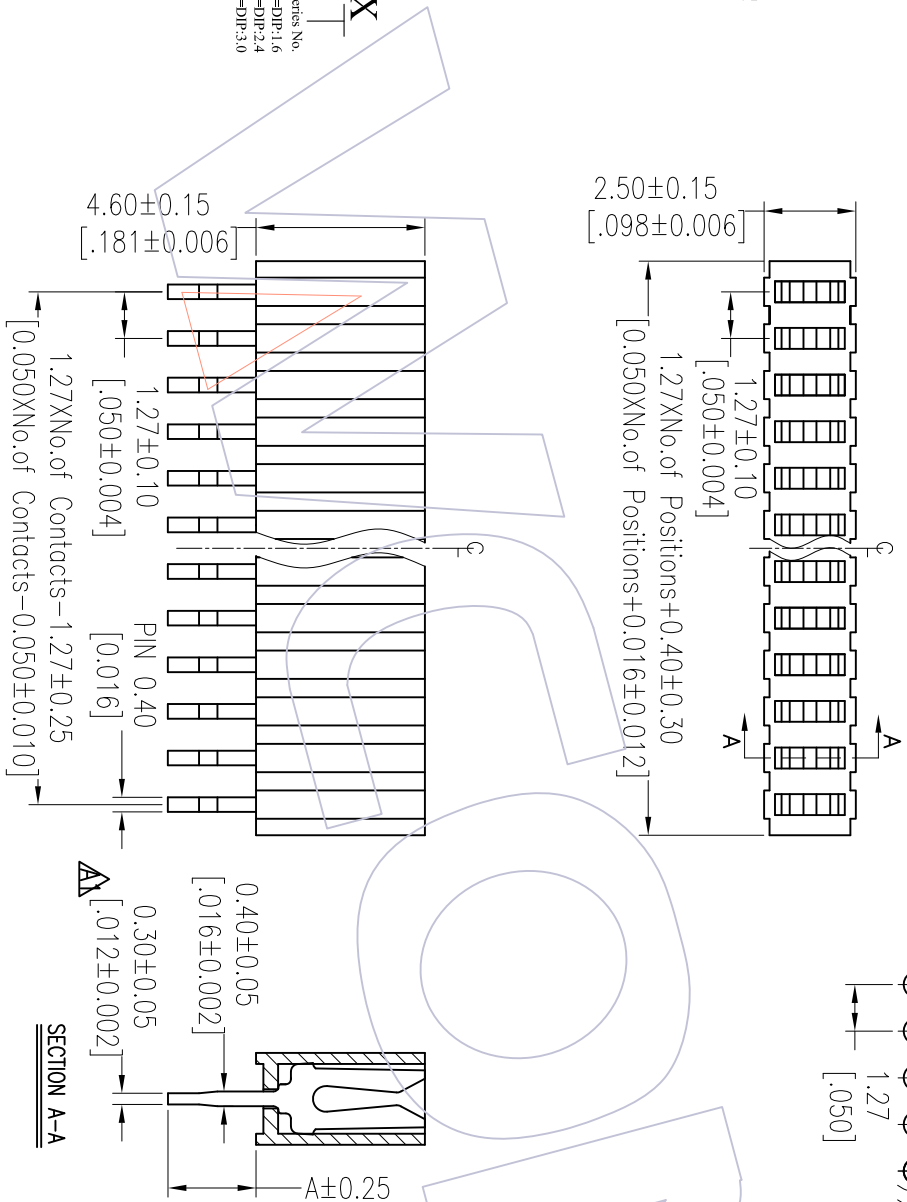
NOTES:

- Current Rating: 1.0AMP
- Contact Resistance: 20mΩ Max
- Withstand Voltage: 500V AC/DC
- Insulation Resistance: 1000MΩ Min
- Operation Temperature: -40°C to +105°C
- Contact Material: Phosphor Bronze
- Contact plating: Au over Ni
- Insulator Material: PA9T+30%GF UL94V-0

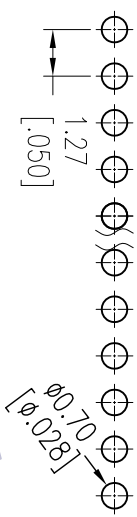
Ordering Information

2346-1 XX S XX CYN T X

No. of Pins per Row: 02-50Pn
 Contact Plating: C0=Gold Flash, G3=10µ"Gold, G4=5µ"Gold, G5=3µ"Gold
 Packing: T=Tube
 Series No.: 1=DP:1.6, 2=DP:2.4, 3=DP:3.0



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Item	Pitch	Mating
Standard	1.27	1317/1325
Alternate		

DIM	PART NO.
A=1.6	2346-1XXSXXCYN11
A=2.4	2346-1XXSXXCYN12
A=3.0	2346-1XXSXXCYN13

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A1	2013/11/08	Add DIM:0.30	-----	XX	Wang	2013/11/08	UNIT	mm	SEE TABLE
A0	2012/07/10	NEW	-----	X.XXX	CHECK	DATE	SIZE	A4	TITLE: FH1. 27mm SINGLE ROW 180° DIP H=4.60
			-----	Angle	APPROVE	DATE	SHEET	1/1	Customer NO.
			-----	DIM	TOL		PROJ.		

WCON

Http: www.wcon.com

WCON-Dongguan
 Tel: +86 769 85358920
 Fax: +86 769 85358915
 E-mail: sales@wcon.com

WCON-Kunshan
 Tel: +86 512 57468408
 Fax: +86 512 57468468
 E-mail: sales@wcon.com